Applicable standard				
Rating	Operating temperature range	-55 °C to +105°C (Note1)	Storage temperature range	-10 °C to +60°C (Note3)
	Operating humidity range	20% to 80% (Note2)	Storage humidity range	40% to 70% (Note3)
	Applicable connector	DF63-3S-3.96C	Voltage	AC/DC 630V
			Current	AWG #16 : 15A AWG #18 : 13A AWG #20 : 11A AWG #22 : 9A

	Rated Voltage	Rated Current	Overvoltage Category	IP-Degree
UL,C-UL	600V AC/DC	See above	-	-
TUV	300V AC/DC	See above	Ⅱ	IP00

Specifications

Item	Test method	Requirements	QT	AT
Construction				
General examination	Visually and by measuring instrument.	According to drawing.	X	X
Marking	Confirmed visually.		X	X
Electric characteristics				
Contact resistance	20mV MAX, 1mA (DC or 1000Hz).	10 mΩ MAX.	X	—
Insulation resistance	500 V DC.	1000 MΩ MIN.	X	—
Voltage proof	1500 V AC for 1 min.	No flashover or breakdown.	X	—
Mechanical characteristics				
Mechanical operation	50 times insertion and extraction.	①Contact resistance: 20 mΩ MAX. ②No damage, crack or looseness of parts.	X	—
Vibration	Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 10 cycles for 3 direction.	①No electrical discontinuity of 1 μs. ②No damage, crack or looseness of parts.	X	—
Shock	490 m/s^2 duration of pulse 11 ms at 3 times each for 3 both axial directions.	①No electrical discontinuity of 1 μs. ②No damage, crack or looseness of parts.	X	—
Environmental characteristics				
Damp heat (Steady state)	Exposed at 40 ± 2℃ , 90 to 95 %, 96 h. (After leaving the room temperature for 1-2h.)	①Contact resistance: 20 mΩ MAX. ②Insulation resistance: 500 MΩ MIN. ③No damage, crack or looseness of parts.	X	—
Rapid change of temperature	Temperature -55℃→ +85℃ Time 30min→ 30min Under 5 cycles. (The transferring time of the tank is 2-3 min) (After leaving the room temperature for 1-2h.)	①Contact resistance: 20 mΩ MAX. ②Insulation resistance: 1000 MΩ MIN. ③No damage, crack or looseness of parts.	X	—
Resistance to Soldering heat △2	1)Solder bath method Soldered at solder temperature, 260°c for in immersion , duration, 5s. 2)Manual soldering Soldering iron temperature :300℃, Soldering time :3s. No strength on contact.	Such as impaired function ,no deformation of case of excessive looseness of the terminals. △2	X	—
Solderability	Soldered at solder temperature, 245°c for in immersion , duration, 5 s.	A new uniform coating of solder shall cover minimum of 95 % of the surface being immersed.	X	—

Note 1: Include the temperature rising by current.
Note 2: No condensing.
Note 3: Apply to the condition of long term storage for unused products before mounted on PCB.
After mounted on PCB, operation temperature and humidity range is applied for interim storage during transportation.

	Count	Description of revisions	Designed	Checked	Date
△2	2	DIS-H-00005520	TO.KUROMATSU	SZ.ONO	20191202

Remarks

Unless otherwise specified, refer to IEC 60512.

Approved	HS.OKAWA	20180129
Checked	TS.FUKUSHIMA	20180129
Designed	TS.KUMAZAWA	20180129
Drawn	TS.KUMAZAWA	20180129

Note QT:Qualification Test AT:Assurance Test X:Applicable Test

Drawing no. ELC-374387-01-00

HRS	Specification sheet	Part no.	DF63M-2P-7.92DSA(01)	
	Hirose electric co., ltd.	Code no.	CL680-0581-0-01 △2	1/1

FORM HD0011-2-1